

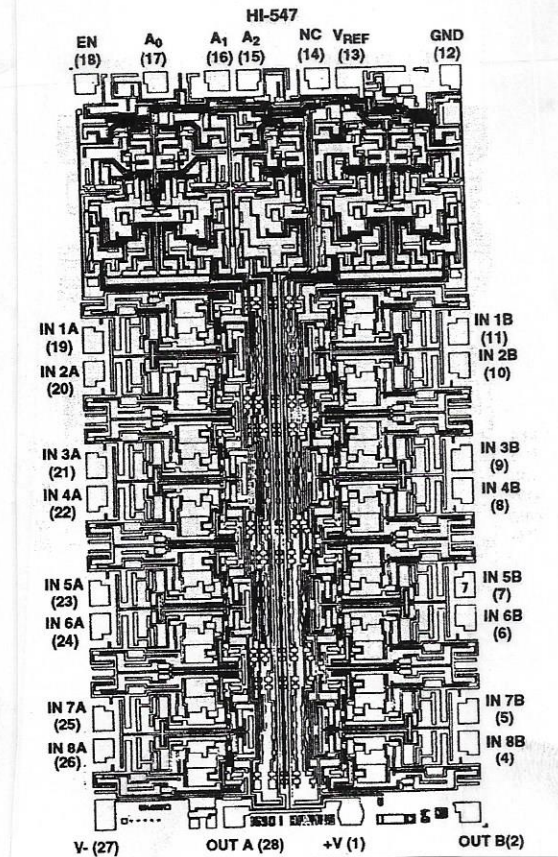


Sierra Components, Inc.

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Chip back potential is the level which bulk silicon is maintained by on-chip connection, or it is the level to which the chip back must be connected when specifically stated below. If no potential is given the chip back should be isolated.



Top Material: Al
 Backside Material: Si
 Bond Pad Size: .004" X .004"
 Backside Potential: -V supply or FLOATING
 Mask Ref: 01710

APPROVED BY: DK

DIE SIZE .084" X159"

DATE: 3/22/19

MFG:HARRIS / INTSL

THICKNESS .019"

P/N: HI0-547